

#### **MOSFET**

#### OptiMOS<sup>™</sup> 3 Power-Transistor, 100 V

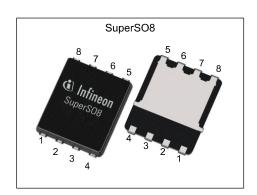
#### **Features**

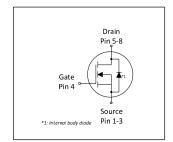
- Very low gate charge for high frequency applications
- Optimized for dc-dc conversionN-channel, normal level

- N-channel, normal level
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  150 °C operating temperature
  Pb-free lead plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target application
  Halogen-free according to IEC61249-2-21



Table 1 Holy 1 direction of the control of the cont							
Parameter	Value	Unit					
V <sub>DS</sub>	100	V					
R <sub>DS(on),max</sub>	6.0	mΩ					
I <sub>D</sub>	105	А					











Type / Ordering Code	Package	Marking	Related Links
BSC060N10NS3 G	PG-TDSON-8	060N10NS	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

D	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	-	105 66 14.9	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 K/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	420	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	230	mJ	$I_{\rm D} = 50 \text{ A}, R_{\rm GS} = 25 \Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	$P_{tot}$	-	-	125	W	T <sub>C</sub> =25 °C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Omit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	1.0	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	$R_{thJA}$	_	_	50	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air. <sup>3)</sup> see Diagram 3



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Damamatan.	Course la sel		Values			Nata / Tank Oan diking	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\mathrm{GS(th)}}$	2.0	2.7	3.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=90\ \mu{\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.01 10	1.0 100	μA	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	1.0	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	5.3 6.6	6.0 11.5	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =6 V, I <sub>D</sub> =25 A	
Gate resistance	R <sub>G</sub>	-	1.6	-	Ω	-	
Transconductance	$g_{fs}$	43	85	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 50 A$	

 Table 5
 Dynamic characteristics

Davamatav	Comple ed	Values			11::4	Note / Test Condition	
Parameter	Symbol		Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	3700	4900	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	650	860	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Reverse transfer capacitance	C <sub>rss</sub>	-	25	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	20	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	16	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	45	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	12	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	

Gate charge characteristics<sup>2)</sup> Table 6

Davamatav	C. mah al	Values			l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	15	-	nC	$V_{DD}$ =50 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V	
Gate to drain charge	$Q_{\mathrm{gd}}$	-	9	-	nC	V <sub>DD</sub> =50 V, I <sub>D</sub> =25 A, V <sub>GS</sub> =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	13	-	nC	$V_{DD}$ =50 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	$Q_g$	-	51	68	nC	$V_{DD}$ =50 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	4.2	-	V	V <sub>DD</sub> =50 V, I <sub>D</sub> =25 A, V <sub>GS</sub> =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	_	68	91	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V	

Defined by design.Not subject to production test See "Gate charge waveforms" for parameter definition

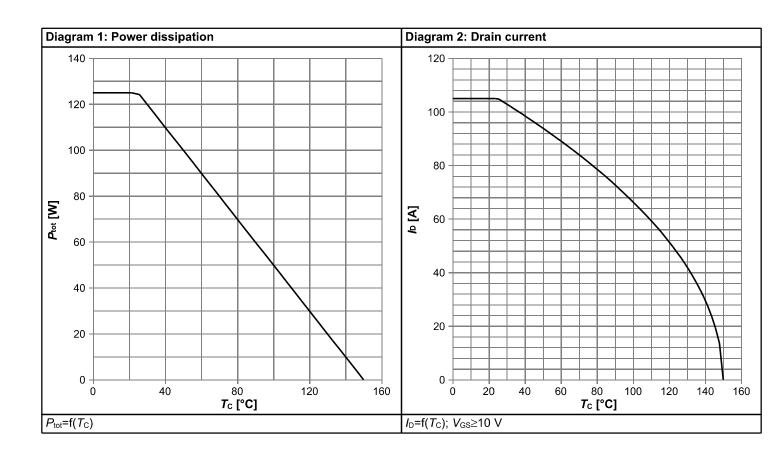


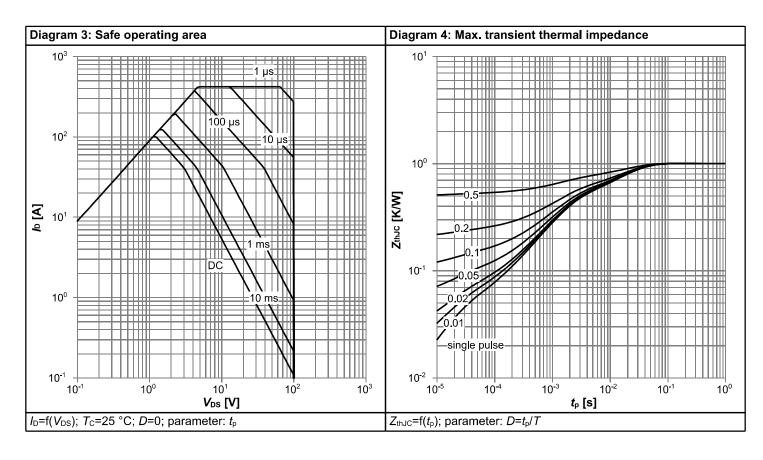
#### Table 7 Reverse diode

Dougnation	C: mah al		Values			Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	_	90	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	420	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.87	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	61	-	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge	Q <sub>rr</sub>	-	109	-	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

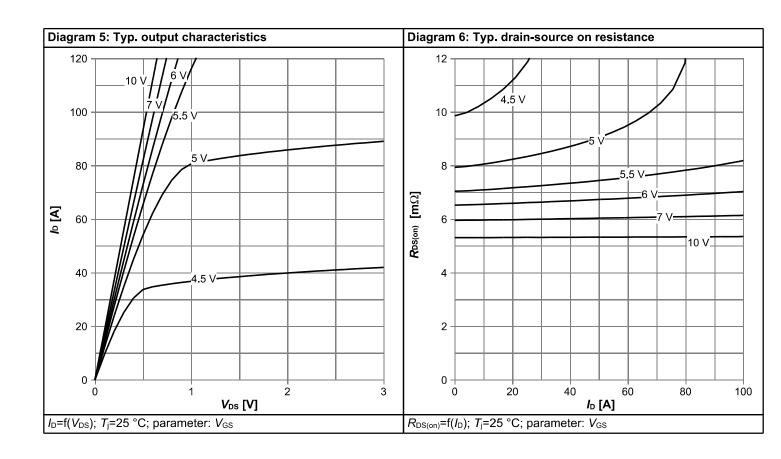


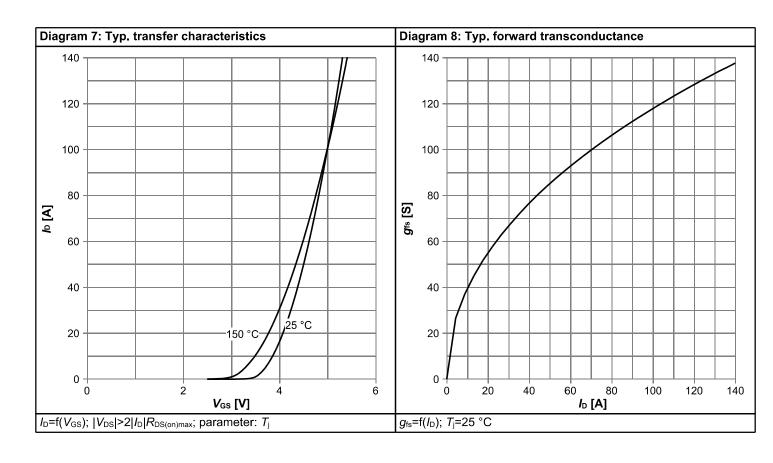
## 4 Electrical characteristics diagrams



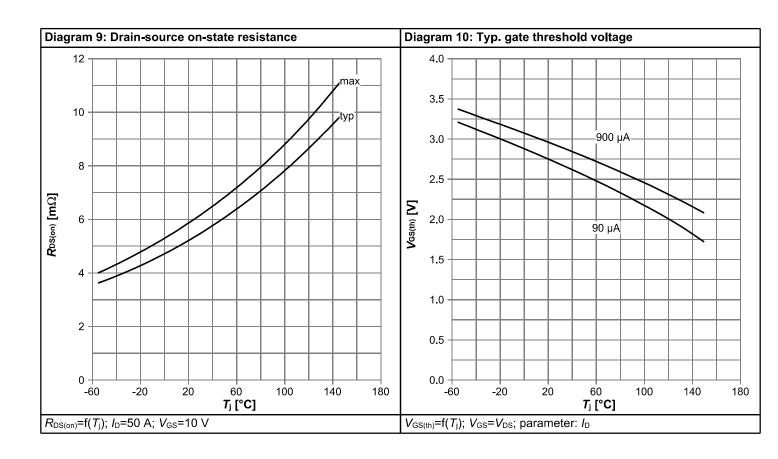


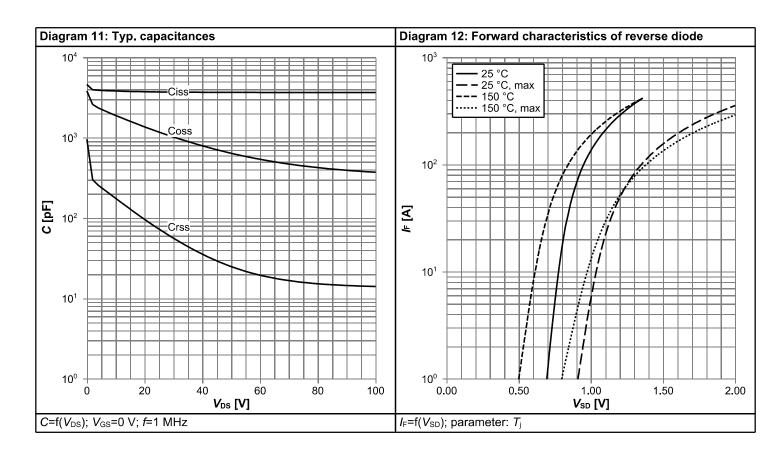




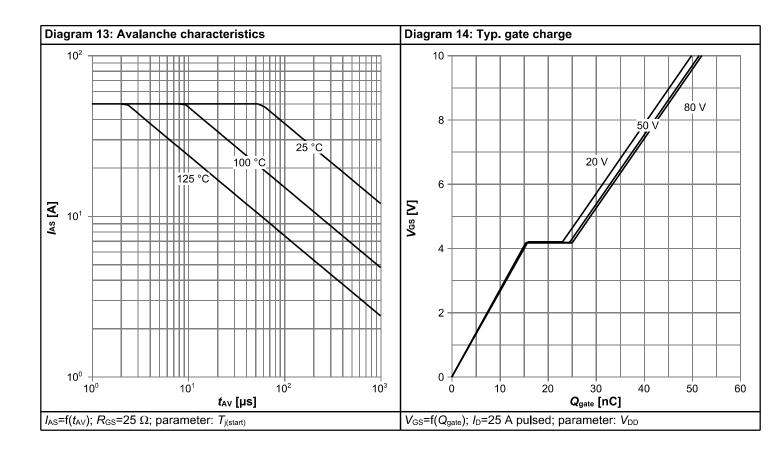


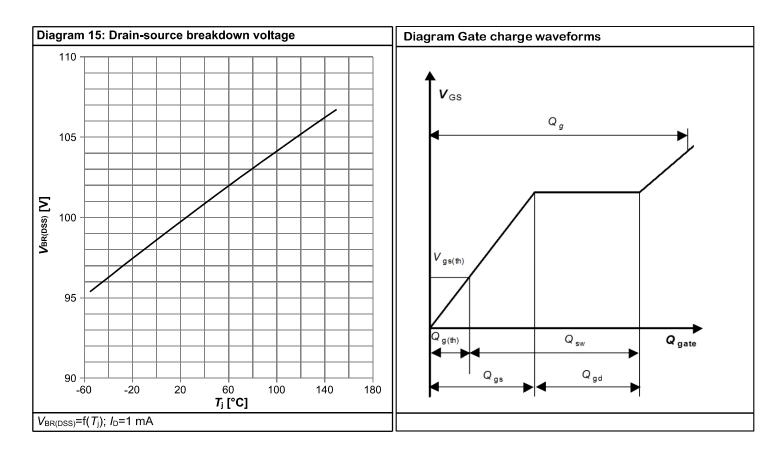






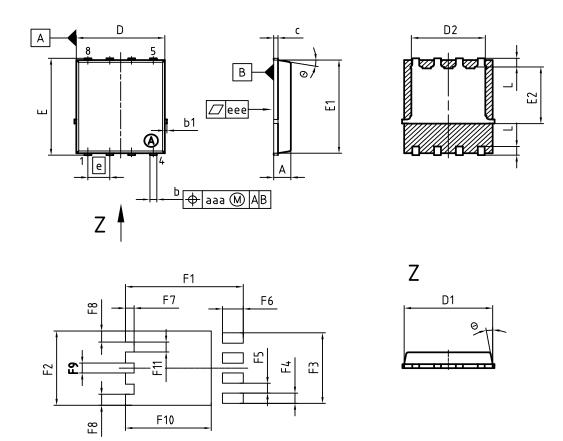








## 5 Package Outlines



DIM	MILLIM	IETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	0.90	1.10	0.035	0.043		
b	0.34	0.54	0.013	0.021		
b1	0.02	0.22	0.001	0.008		
С	0.15	0.35	0.006	0.014		
D=D1	4.95	5.35	0.195	0.211		
D2	4.20	4.40	0.165	0.173		
Е	5.95	6.35	0.234	0.250		
E1	5.70	6.10	0.224	0.240		
E2	3.40	3.80	0.134	0.150		
е	1.2	27	0.0	050		
N		8	8			
L	0.45	0.65	0.018	0.026		
Θ	8.5°	11.5°	8.5°	11.5°		
aaa	0.2	25	0.0	010		
eee	0.0	05	0.0	002		
F1	6.75	6.95	0.266	0.274		
F2	4.60	4.80	0.181	0.189		
F3	4.36	4.56	0.172	0.180		
F4	0.55	0.75	0.022	0.030		
F5	0.52	0.72	0.020	0.028		
F6	1.10	1.30	0.043	0.051		
F7	0.40	0.60	0.016	0.024		
F8	0.60	0.80	0.024	0.031		
F9	0.53	0.73	0.021	0.029		
F10	4.90	5.10	0.193	0.201		
F11	0.53	0.73	0.021	0.029		

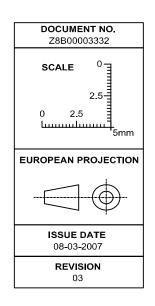


Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



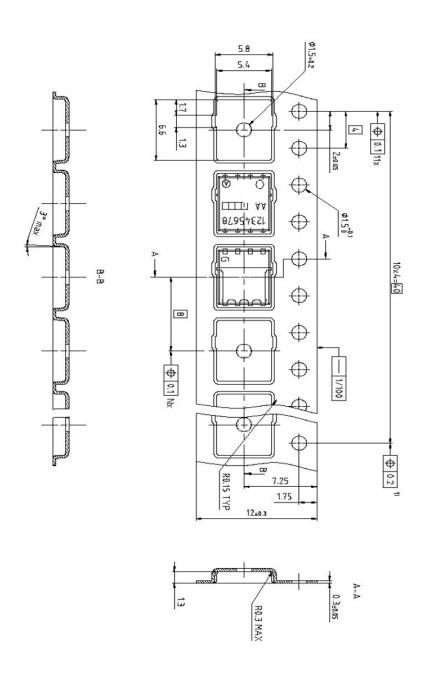


Figure 2 Outline Tape (PG-TDSON-8), dimensions in mm



#### **Revision History**

BSC060N10NS3 G

Revision: 2021-04-20, Rev. 2.5

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.5	2021-04-20	Update current rating and footnotes

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